

CGY2178UH/C1

Rev. V1

Features

- C-band MMIC LNA
- S11, S22:
 - <-15 dB (7.5% Bandwidth)
 - < -10 dB (5 6 GHz)
- Noise Figure: 1 dB
- Gain: 30 dB
- OIP3: 22 dBm
- Output P1dB: 15 dBm
- Circuit Size: 1.5 mm x 1.6 mm, 100 µm thick
- 100% RF Tested, Known Good Die
- Uses a highly reliable pHEMT MMIC process
- Demonstration Boards Available
- Samples Available
- RoHS* Compliant

Applications

- C-Band Active Antennas
- General Purpose

Description

The CGY2178UH/C1 is a high gain, low noise figure MMIC amplifier designed for use with the integrated core chip, attenuator/phase shifter chip set or as a general purpose low noise amplifier in band C. The CGY2178UH/C1 uses a simple external matching circuit to provide excellent input matching and low noise figure between 5 and 6 GHz. All biasing, decoupling and output-matching networks are on chip.

The MMIC is manufactured with a 0.18 μm PHEMT GaAs MMIC technology. The device is fully passivated.



Ordering Information

Part Number	Package
CGY2178UH/C1	MMIC C-Band LNA

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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Electrical Specifications¹: Measured On Reference Board, Freq. = 5.3 GHz, V_{D1} = V= 3 V, I_{D1} = 10 mA, I_{D2} = 30 mA, T_A = +25°C

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Gain	—	dB		30	—
Noise Figure	_	dB		1.05	
Reverse Isolation	Out/In	dB		40	
Output IP3	_	dBm		22	
Output P1dB	_	dBm		15	
Input Return Loss	50 Ω Source	dB		-15	
Output Return Loss	50 Ω Load	dB	_	-15	—

1. Measurement reference planes are the INPUT and OUTPUT SMA connectors.

Absolute Maximum Ratings^{2,3}

Parameter	Absolute Maximum
Input Power	5 dBm
Gate Voltage ⁴ Stage 1 & Stage 2	-6 to 0 V
Drain Voltage Stage 1 & Stage 2	0 to +6 V
Drain Current Stage 1 Stage 2	40 mA 60 mA
Gate Current	10 mA
Junction Temperature	+150°C
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +150°C

2. Exceeding any one or combination of these limits may cause permanent damage to this device.

MACOM does not recommend sustained operation near these survivability limits.

4. VD1 Open Circuited

Thermal Characteristics

Parameter	Absolute Maximum
Thermal Resistance	235°C/W

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

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Typical Performance Curves: 5.3 GHz Optimized

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Reference Board



Bill of materials

INPUT matching (see note 1):

Optimised for 5300 MHz. L1, L2 and L3 are coplanar transmission lines.

Component	Length (µm)	Width (µm)	Gap (µm)
L1	2600	200	200
L2	3500	200	200
L3	4000	200	200

Note 1: Dimensions are given for Rogers RO4003 substrate material. (Height = 800 μ m, E_r = 3.4).

Component	Value	Reference	
C1, C2, C3, C4	100 nF	0603	

Circuit Diagram



CGY2178UH Reference Board



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Block Diagram



Pin Configuration

Pin #	Pin Name	Description
1,3,5,9,10,12,15	GND	Ground
2	IN	RF Input
4	V _{G1}	Stage 1: Gate Biasing
6	V _{GC}	Connected to V _{D1}
7,8	V _{G1}	Stage 1: Drain Biasing
11	OUT	RF Output
13,14	V _{D2}	Stage 2: Drain Biasing
16	V _{G2}	Stage 2: Gate Biasing



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Mechanical Information



Chip Size: 1500 x 1600 μm (±15 μm) GND, VG1, VGC, VD1, VG2, VD2: 100 x 100 μm In, OUT: 80 x 80 μm Substrate Thickness: 100 μm Backside Metal: TiAu Passivation: PECVD deposited Si_3N_4

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